











#### SN54LV594A, SN74LV594A

SCLS413J - APRIL 2005-REVISED MARCH 2015

## SNx4LV594A 8-Bit Shift Registers With Output Registers

#### **Features**

- 2-V to 5.5-V V<sub>CC</sub> Operation
- Maximum tpd of 6.5 ns at 5 V
- Typical  $V_{OLP}$  (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3 \text{ V}, \text{TA} = 25^{\circ}\text{C}$
- Support Mixed-Mode Voltage Operation on All **Ports**
- 8-Bit Serial-In, Parallel-Out Shift Registers With
- Independent Direct Overriding Clears on Shift and Storage Registers
- Independent Clocks for Shift and Storage Registers
- Latch-up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

### 2 Applications

- ECG Electrocardiograms
- Storage Servers
- EPOS, ECR, and Cash Drawers
- Servers and High-Performance Computing

### 3 Description

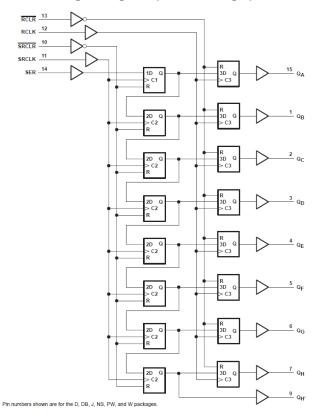
The SN74LV594A devices are 8-bit shift registers designed for 2-V to 5.5-V V<sub>CC</sub> operation.

#### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)   |
|-------------|------------|-------------------|
|             | SSOP (16)  | 6.20 mm × 5.30 mm |
| SN74LV594A  | SOIC (16)  | 9.90 mm × 3.91 mm |
|             | TSSOP (16) | 5.00 mm × 4.40 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### **Logic Diagram (Positive Logic)**





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#### 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

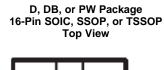
#### Changes from Revision I (April 2005) to Revision J

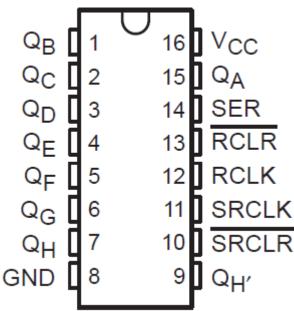
**Page** 

Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional
Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device
and Documentation Support section, and Mechanical, Packaging, and Orderable Information section



## 5 Pin Configuration and Functions





#### **Pin Functions**

|     | PIN            | 1/0 | DECORPORTION            |
|-----|----------------|-----|-------------------------|
| NO. | NAME           | I/O | DESCRIPTION             |
| 1   | $Q_{B}$        | 0   | Output B                |
| 2   | $Q_{C}$        | 0   | Output C                |
| 3   | $Q_D$          | 0   | Output D                |
| 4   | $Q_{E}$        | 0   | Output E                |
| 5   | $Q_{F}$        | 0   | Output F                |
| 6   | $Q_{G}$        | 0   | Output G                |
| 7   | $Q_H$          | 0   | Output H                |
| 8   | GND            | _   | Ground pin              |
| 9   | $Q_{H'}$       | 0   | Q <sub>H</sub> inverted |
| 10  | SRCLR          | 1   | Serial clear            |
| 11  | SRCLK          | 1   | Serial clock            |
| 12  | RCLK           | 1   | Storage clock           |
| 13  | RCLR           | I   | Storage clear           |
| 14  | SER            | I   | Serial input            |
| 15  | Q <sub>A</sub> | 0   | Output A                |
| 16  | Vcc            | -   | Power pin               |



### 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

|                  |  |                             | MIN  | MAX                   | UNIT |
|------------------|--|-----------------------------|------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage   |                             | -0.5 | 7                     | V    |
| VI               | Input voltage <sup>(2)</sup>                           |                             | -0.5 | 7                     | V    |
| Vo               | Voltage range applied to any output in the high-impeda | ince or power-off state (2) | -0.5 | 7                     | V    |
| Vo               | Output voltage (2)(3)                                  |                             | -0.5 | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current                                    | V <sub>I</sub> < 0          | -20  |                       | mA   |
| I <sub>OK</sub>  | Output clamp current                                   | V <sub>O</sub> < 0          | -50  |                       | mA   |
| Io               | Continuous output current                              | $V_O = 0$ to $V_{CC}$       | -25  | 25                    | mA   |
| T <sub>stg</sub> | Storage temperature                                    |                             | -65  | 150                   | °C   |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

|                    |                         |   | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
|                    |                         | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)              | 2000  |      |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | 1000  | V    |

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

<sup>2)</sup> The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(3)</sup> The value is limited to 5.5 V maximum.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



## 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)(1)

|                 |   |  | SN54LV5               | 94A <sup>(2)</sup>  | SN74L\              | /594A               |      |
|-----------------|---|--|-----------------------|---------------------|---------------------|---------------------|------|
|                 |   |  | MIN                   | MAX                 | MIN                 | MAX                 | UNIT |
| V <sub>CC</sub> | Supply voltage  |  | 2                     | 5.5                 | 2                   | 5.5                 | V    |
|                 |   | V <sub>CC</sub> = 2 V  | 1.5                   |                     | 1.5                 |                     |      |
| \ /             | Liber level beaut veltere   | V <sub>CC</sub> = 2.3 V to 2.7 V   | V <sub>CC</sub> × 0.7 |                     | $V_{CC} \times 0.7$ |                     | V    |
| $V_{IH}$        | High-level input voltage  | V <sub>CC</sub> = 3 V to 3.6 V   | V <sub>CC</sub> × 0.7 |                     | $V_{CC} \times 0.7$ |                     | V    |
|                 |   | V <sub>CC</sub> = 4.5 V to 5.5 V   | V <sub>CC</sub> × 0.7 |                     | $V_{CC} \times 0.7$ |                     |      |
|                 |   | V <sub>CC</sub> = 2 V  |                       | 0.5                 |                     | 0.5                 |      |
| \ /             | Law lawal iam structura   | V <sub>CC</sub> = 2.3 V to 2.7 V   |                       | $V_{CC} \times 0.3$ |                     | $V_{CC} \times 0.3$ | V    |
| $V_{IL}$        | Low-level input voltage   | V <sub>CC</sub> = 3 V to 3.6 V   |                       | $V_{CC} \times 0.3$ |                     | $V_{CC} \times 0.3$ | V    |
|                 |   | V <sub>CC</sub> = 4.5 V to 5.5 V   |                       | $V_{CC} \times 0.3$ |                     | $V_{CC} \times 0.3$ |      |
| $V_{I}$         | Input voltage   | •  | 0                     | 5.5                 | 0                   | 5.5                 | V    |
| Vo              | Output voltage  |  | 0                     | V <sub>CC</sub>     | 0                   | $V_{CC}$            | V    |
| v <sub>O</sub>  |   | V <sub>CC</sub> = 2 V  |                       | -50                 |                     | -50                 | μA   |
|                 | Ulab lavalianut avanant   | V <sub>CC</sub> = 2.3 V to 2.7 V   |                       | -2                  |                     | -2                  |      |
| I <sub>OH</sub> | High-level input current  | V <sub>CC</sub> = 3 V to 3.6 V   |                       | 6                   |                     | 6                   | mA   |
|                 |   | V <sub>CC</sub> = 4.5 V to 5.5 V   |                       | -12                 |                     | -12                 |      |
|                 |   | V <sub>CC</sub> = 2 V  |                       | 50                  |                     | 50                  | μA   |
|                 | Laurence autout aumant  | V <sub>CC</sub> = 2.3 V to 2.7 V   |                       | 2                   |                     | 2                   |      |
| l <sub>OL</sub> | Low-level output current  | V <sub>CC</sub> = 3 V to 3.6 V   |                       | 6                   |                     | 6                   | mA   |
|                 |   | V <sub>CC</sub> = 4.5 V to 5.5 V   |                       | 12                  |                     | 12                  |      |
|                 |   |  |                       | 200                 |                     | 200                 |      |
| Δt/Δν           | Input transition rise or fall re<br>$V_{CC} = 4.5 \text{ V}$ to 5.5 V | ate $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V } V_{CC} = 3 \text{ V to } 3.6 \text{ V}$ |                       | 100                 |                     | 100                 | ns/V |
|                 | VUC - 7.0 V 10 0.0 V  | CC = 4.5 V to 5.5 V  |                       | 20                  |                     | 20                  |      |
| T <sub>A</sub>  | Operating free-air temperat   | ture   | -55                   | 125                 | -40                 | 125                 | °C   |

<sup>(1)</sup> All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report *Implications of Slow or Floating CMOS Inputs*, SCBA004.

#### 6.4 Thermal Information

|                      |  |          | SN74LV594A |            |      |  |  |  |  |
|----------------------|--|----------|------------|------------|------|--|--|--|--|
|                      | THERMAL METRIC <sup>(1)</sup>                | D (SOIC) | DB (SSOP)  | PW (TSSOP) | UNIT |  |  |  |  |
|                      |  | 16 PINS  | 16 PINS    | 16 PINS    |      |  |  |  |  |
| $R_{\theta JA}$      | Junction-to-ambient thermal resistance       | 80.2     | 97.8       | 106.1      |      |  |  |  |  |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance    | 40.3     | 48.1       | 40.8       |      |  |  |  |  |
| $R_{\theta JB}$      | Junction-to-board thermal resistance         | 38       | 48.5       | 51.1       | °C/W |  |  |  |  |
| ΨЈТ                  | Junction-to-top characterization parameter   | 9        | 10         | 3.8        |      |  |  |  |  |
| $\psi_{JB}$          | Junction-to-board characterization parameter | 37.7     | 47.9       | 50.6       |      |  |  |  |  |

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

<sup>(2)</sup> Product Preview



#### 6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST<br>CONDITIONS               | vcc          | SN54                  | LV594A |      | SN74LV594A<br>-40°C TO 85°C |     |      | SN74LV594A<br>-40°C TO 125°C |     |      | UNIT |
|------------------|----------------------------------|--------------|-----------------------|--------|------|-----------------------------|-----|------|------------------------------|-----|------|------|
|                  | CONDITIONS                       |              | MIN                   | TYP    | MAX  | MIN                         | TYP | MAX  | MIN                          | TYP | MAX  |      |
|                  | $I_{OH} = -50 \ \mu A$           | 2 V to 5.5 V | V <sub>CC</sub> - 0.1 |        |      | V <sub>CC</sub> - 0.1       |     |      | V <sub>CC</sub> - 0.1        |     |      |      |
| <b>V</b>         | I <sub>OH</sub> = -2 μA          | 2.3 V        | 2                     |        |      | 2                           |     |      | 2                            |     |      | V    |
| V <sub>OH</sub>  | $I_{OH} = -6 \mu A$              | 3 V          | 2.48                  |        |      | 2.48                        |     |      | 2.48                         |     |      | V    |
|                  | $I_{OH} = -12 \mu A$             | 4.5 V        | 3.8                   |        |      | 3.8                         |     |      | 3.8                          |     |      |      |
|                  | $I_{OH} = -50 \mu A$             | 2 V to 5.5 V |                       |        | 0.1  |                             |     | 0.1  |                              |     | 0.1  |      |
|                  | $I_{OH} = -2 \mu A$              | 2.3 V        |                       |        | 0.4  |                             |     | 0.4  |                              |     | 0.4  | V    |
| V <sub>OL</sub>  | I <sub>OH</sub> = -6 μA          | 3 V          |                       |        | 0.44 |                             |     | 0.44 |                              |     | 0.44 | V    |
|                  | $I_{OH} = -12 \mu A$             | 4.5 V        |                       |        | 0.55 |                             |     | 0.55 |                              |     | 0.55 |      |
| I <sub>I</sub>   | V <sub>I</sub> = 5.5 V or<br>GND | 0 to 5.5 V   |                       |        | ±1   |                             |     | ±1   |                              |     | ±1   | μA   |
| I <sub>cc</sub>  | $V_I = V_{CC}$ of GND, $I_O = 0$ | 5.5 V        |                       |        | 20   |                             |     | 20   |                              |     | 20   | μA   |
| I <sub>off</sub> | $V_I$ or $V_O = 0$<br>to 5.5 V   | 0            |                       |        | 5    |                             |     | 5    |                              |     | 5    | μA   |
| Ci               | $V_I = V_{CC}$ or GND            | 3.3 V        |                       | 3.5    |      |                             | 3.5 |      |                              |     |      | pF   |

## 6.6 Switching Characteristics: $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range,  $V_{CC}$  = 2.5 V ± 0.2 V (unless otherwise noted). See Figure 1.

| PARAMETER        | FROM<br>(INPUT) | TO               | LOAD                   | 1                 | Γ <sub>A</sub> = 25°0 | 3                   | SN54lv            | /594A              | SN74LV<br>-40°C TO |      | SN74LV5<br>-40°C TO |      | UNIT  |   |      |  |
|------------------|-----------------|------------------|------------------------|-------------------|-----------------------|---------------------|-------------------|--------------------|--------------------|------|---------------------|------|-------|---|------|--|
|                  | (INPUT)         | (OUTPUT)         | CAPACITANCE            | MIN               | TYP                   | MAX                 | MIN               | MAX                | MIN                | MAX  | MIN                 | MAX  |       |   |      |  |
|                  |                 |                  | C <sub>L</sub> = 15 pF | 65 <sup>(1)</sup> | 80 <sup>(1)</sup>     |                     | 45 <sup>(1)</sup> |                    | 45                 |      | 35                  |      | MHz   |   |      |  |
| f <sub>max</sub> |                 |                  | C <sub>L</sub> = 50 pF | 60                | 70                    |                     | 40                |                    | 40                 |      | 30                  |      | IVITZ |   |      |  |
| t <sub>PLH</sub> |                 | 0 0              |                        |                   | 6.4 <sup>(1)</sup>    | 10.6 <sup>(1)</sup> | 1 <sup>(1)</sup>  | 11.1(1             | 1                  | 11.1 | 1                   | 12.5 |       |   |      |  |
| t <sub>PHL</sub> | SRCLK           | $Q_A - Q_H$      |                        |                   | 6.3 <sup>(1)</sup>    | 10.4 <sup>(1)</sup> | 1 <sup>(1)</sup>  | 11.1(1             | 1                  | 11.1 | 1                   | 12.5 |       |   |      |  |
| t <sub>PLH</sub> |                 | 0                | C 45 75                |                   | 7.4 <sup>(1)</sup>    | 12.1 <sup>(1)</sup> | 1 <sup>(1)</sup>  | 12.8(1             | 1                  | 12.8 | 1                   | 15   |       |   |      |  |
| t <sub>PHL</sub> |                 | Q <sub>H</sub>   | C <sub>L</sub> = 15 pF |                   | 7.2 <sup>(1)</sup>    | 11.6 <sup>(1)</sup> | 1 <sup>(1)</sup>  | 12.8(1             | 1                  | 12.8 | 1                   | 15   | ns    |   |      |  |
|                  | RCLK            | $Q_A - Q_H$      |                        |                   | 7.9 <sup>(1)</sup>    | 12.7 <sup>(1)</sup> | 1 <sup>(1)</sup>  | 13.6(1             | 1                  | 13.6 | 1                   | 15.5 |       |   |      |  |
| t <sub>PHL</sub> |                 | Q <sub>H</sub> , |                        |                   | 7.4 <sup>(1)</sup>    | 11.9 <sup>(1)</sup> | 1 <sup>(1)</sup>  | 13.1 <sup>(1</sup> | 1                  | 13.1 | 1                   | 15.5 |       |   |      |  |
| t <sub>PLH</sub> |                 | 0 0              |                        |                   | 9.5                   | 14.1                | 1                 | 14.6               | 1                  | 14.6 | 1                   | 17   |       |   |      |  |
| t <sub>PHL</sub> | SRCLR           | $Q_A - Q_H$      |                        |                   | 10.8                  | 15.5                | 1                 | 17.2               | 1                  | 17.2 | 1                   | 19.5 |       |   |      |  |
| t <sub>PLH</sub> | OKOLK           | - 3.102.1        | - OROLIN               | JINOLK            |                       | C 50 7 5            |                   | 10.6               | 15.7               | 1    | 16.5                | 1    | 16.5  | 1 | 18.5 |  |
| t <sub>PHL</sub> |                 | Q <sub>H</sub> ' | $C_L = 50 \text{ pF}$  |                   | 11.3                  | 16.1                | 1                 | 18.6               | 1                  | 18.6 | 1                   | 20.5 | ns    |   |      |  |
|                  | RCLR            | $Q_A - Q_H$      |                        |                   | 12.1                  | 17.4                | 1                 | 19                 | 1                  | 19   | 1                   | 21   |       |   |      |  |
| t <sub>PHL</sub> |                 | Q <sub>H</sub>   |                        |                   | 11.6                  | 16.5                | 1                 | 18.6               | 1                  | 18.6 | 1                   | 20.6 |       |   |      |  |

<sup>(1)</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.



## 6.7 Switching Characteristics: $V_{cc} = 3.3 \text{ V} \pm 0.3 \text{ V}$

over recommended operating free-air temperature range,  $V_{CC}$  = 3.3 V  $\pm$  0.3 V (unless otherwise noted). See Figure 1.

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT)                    | LOAD<br>CAPACITANCE    | T                      | <sub>\(\)</sub> = 25°C |                    | SN54L              | .V594A              | SN74LV<br>-40°C TO |      | SN74LV5<br>–40°C TO |      | UNIT  |    |
|------------------|-----------------|-----------------------------------|------------------------|------------------------|------------------------|--------------------|--------------------|---------------------|--------------------|------|---------------------|------|-------|----|
|                  | (INFOT)         | (OUTFUT)                          | CAPACITANCE            | MIN                    | TYP                    | MAX                | MIN                | MAX                 | MIN                | MAX  | MIN                 | MAX  |       |    |
|                  |                 |                                   | C <sub>L</sub> = 15 pF | 80(1)                  | 120 <sup>(1)</sup>     |                    | 70 <sup>(1)</sup>  |                     | 70                 |      | 60                  |      | MHz   |    |
| f <sub>max</sub> |                 |                                   | C <sub>L</sub> = 50 pF | 55                     | 105                    |                    | 50                 |                     | 50                 |      | 40                  |      | IVITZ |    |
| t <sub>PLH</sub> |                 | 0 0                               |                        |                        | 4.6 <sup>(1)</sup>     | 8 <sup>(1)</sup>   | 1 <sup>(1)</sup>   | 8.5 <sup>(1)</sup>  | 1                  | 8.5  | 1                   | 10.5 |       |    |
| t <sub>PHL</sub> | SRCLK           | $R = \frac{Q_A - Q_H}{Q_A - Q_H}$ |                        |                        | 4.9 <sup>(1)</sup>     | 8.2 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 8.8(1)              | 1                  | 8.8  | 1                   | 10.5 |       |    |
| t <sub>PLH</sub> |                 | 0                                 | 0 45 -5                |                        | 5.4 <sup>(1)</sup>     | 9.1 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 9.7 <sup>(1)</sup>  | 1                  | 9.7  | 1                   | 11.5 |       |    |
| t <sub>PHL</sub> |                 |                                   | Q <sub>H</sub> ,       | C <sub>L</sub> = 15 pF |                        | 5.5 <sup>(1)</sup> | 9.2 <sup>(1)</sup> | 1 <sup>(1)</sup>    | 9.9 <sup>(1)</sup> | 1    | 9.9                 | 1    | 11.6  | ns |
|                  | RCLK            | $Q_A - Q_H$                       |                        |                        | 6 <sup>(1)</sup>       | 9.8 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 10.6 <sup>(1)</sup> | 1                  | 10.6 | 1                   | 12.1 |       |    |
| t <sub>PHL</sub> |                 | Q <sub>H</sub> ,                  |                        |                        | 5.6 <sup>(1)</sup>     | 9.2 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 10 <sup>(1)</sup>   | 1                  | 10   | 1                   | 12   |       |    |
| t <sub>PLH</sub> |                 | 0 0                               |                        |                        |                        |                    | 1                  | 11.1                | 1                  | 11.1 | 1                   | 12.5 |       |    |
| t <sub>PHL</sub> | SRCLR           | $Q_A - Q_H$                       |                        |                        |                        |                    | 1                  | 13.1                | 1                  | 13.1 | 1                   | 15   |       |    |
| t <sub>PLH</sub> |                 | 0                                 | 0 50 - 5               |                        |                        |                    | 1                  | 12.4                | 1                  | 12.4 | 1                   | 14   |       |    |
| t <sub>PHL</sub> |                 | Q <sub>H</sub> ,                  | $C_L = 50 pF$          |                        |                        |                    | 1                  | 13.9                | 1                  | 13.9 | 1                   | 15.5 | ns    |    |
| t <sub>PHL</sub> | RCLR            | $Q_A - Q_H$                       |                        |                        |                        |                    | 1                  | 14.4                | 1                  | 14.4 | 1                   | 16.1 |       |    |
|                  |                 | Q <sub>H</sub>                    |                        |                        |                        |                    | 1                  | 14                  | 1                  | 14   | 1                   | 16   |       |    |

<sup>(1)</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

## 6.8 Switching Characteristics: $V_{CC} = 5 V \pm 0.5 V$

over recommended operating free-air temperature range,  $V_{CC}$  = 5 V  $\pm$  0.5 V (unless otherwise noted). See Figure 1.

| PARAMETER        | FROM<br>(INPUT) |                  | LOAD                   | Т,                 | <sub>4</sub> = 25°C |                    | SN54L              | V594A              | SN74LV<br>-40°C TO |      | SN74LV59<br>-40°C TO 1 |      | UNIT  |    |  |     |     |   |     |   |     |   |     |  |
|------------------|-----------------|------------------|------------------------|--------------------|---------------------|--------------------|--------------------|--------------------|--------------------|------|------------------------|------|-------|----|--|-----|-----|---|-----|---|-----|---|-----|--|
|                  | (INPUT)         | (OUTPUT)         | CAPACITANCE            | MIN                | TYP                 | MAX                | MIN                | MAX                | MIN                | MAX  |                        |      |       |    |  |     |     |   |     |   |     |   |     |  |
|                  |                 |                  | C <sub>L</sub> = 15 pF | 135 <sup>(1)</sup> | 170 <sup>(1)</sup>  |                    | 115 <sup>(1)</sup> |                    | 115                |      | 105                    |      | MHz   |    |  |     |     |   |     |   |     |   |     |  |
| f <sub>max</sub> |                 |                  | C <sub>L</sub> = 50 pF | 120                | 140                 |                    | 95                 |                    | 95                 |      | 85                     |      | IVITZ |    |  |     |     |   |     |   |     |   |     |  |
| t <sub>PLH</sub> |                 | 0 0              |                        |                    | 3.3 <sup>(1)</sup>  | 6.2 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 6.5 <sup>(1)</sup> | 1                  | 6.5  | 1                      | 8    |       |    |  |     |     |   |     |   |     |   |     |  |
| t <sub>PHL</sub> | SRCLK           | $Q_A - Q_H$      |                        |                    | 3.7 <sup>(1)</sup>  | 6.5 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 6.9 <sup>(1)</sup> | 1                  | 6.9  | 1                      | 8.5  |       |    |  |     |     |   |     |   |     |   |     |  |
| t <sub>PLH</sub> |                 | 0                | C <sub>1</sub> = 15 pF |                    | 3.7 <sup>(1)</sup>  | 6.8 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 7.2 <sup>(1)</sup> | 1                  | 7.2  | 1                      | 8.5  |       |    |  |     |     |   |     |   |     |   |     |  |
| t <sub>PHL</sub> | RCLK            |                  | Q <sub>H</sub>         | OL = 13 pi         |                     | 4.1 <sup>(1)</sup> | 7.2 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 7.6 <sup>(1)</sup> | 1    | 7.6                    | 1    | 9     | ns |  |     |     |   |     |   |     |   |     |  |
|                  |                 | $Q_A - Q_H$      |                        |                    | 4.5 <sup>(1)</sup>  | 7.6 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 8.2 <sup>(1)</sup> | 1                  | 8.2  | 1                      | 9.5  |       |    |  |     |     |   |     |   |     |   |     |  |
| t <sub>PHL</sub> |                 | Q <sub>H</sub>   |                        |                    | 4.1 <sup>(1)</sup>  | 7.1 <sup>(1)</sup> | 1 <sup>(1)</sup>   | 7.6 <sup>(1)</sup> | 1                  | 7.6  | 1                      | 9    |       |    |  |     |     |   |     |   |     |   |     |  |
| t <sub>PLH</sub> |                 |                  |                        |                    |                     |                    |                    |                    |                    |      |                        |      | 0 0   |    |  | 4.9 | 7.8 | 1 | 8.3 | 1 | 8.3 | 1 | 9.6 |  |
| t <sub>PHL</sub> | SRCLR           | $Q_A - Q_H$      |                        |                    | 5.8                 | 8.9                | 1                  | 9.7                | 1                  | 9.7  | 1                      | 11   |       |    |  |     |     |   |     |   |     |   |     |  |
| t <sub>PLH</sub> |                 | 0                | 0 50 5                 |                    | 5.5                 | 8.6                | 1                  | 9.1                | 1                  | 9.1  | 1                      | 10.5 |       |    |  |     |     |   |     |   |     |   |     |  |
| t <sub>PHL</sub> |                 | Q <sub>H</sub> ' | $C_L = 50 \text{ pF}$  |                    | 6                   | 9.2                | 1                  | 10.1               | 1                  | 10.1 | 1                      | 11.5 | ns    |    |  |     |     |   |     |   |     |   |     |  |
|                  | RCLR            | $Q_A - Q_H$      |                        |                    | 6.6                 | 10                 | 1                  | 10.7               | 1                  | 10.7 | 1                      | 12   |       |    |  |     |     |   |     |   |     |   |     |  |
| PHL              |                 | Q <sub>H</sub> ' |                        |                    | 6                   | 9.2                | 1                  | 10.1               | 1                  | 10.1 | 1                      | 11.5 |       |    |  |     |     |   |     |   |     |   |     |  |

<sup>(1)</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.



### 6.9 Timing Requirements: $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range,  $V_{CC}$  = 2.5 V ± 0.2 V. See Figure 1.

|                 |                |                                     | T <sub>A</sub> = 2 | 5°C | SN54LV | 594A | SN74LV<br>-40°C TO |     | SN74LV5<br>-40°C TO 1 |     | UNIT |
|-----------------|----------------|-------------------------------------|--------------------|-----|--------|------|--------------------|-----|-----------------------|-----|------|
|                 |                |                                     | MIN                | MAX | MIN    | MAX  | MIN                | MAX | MIN                   | MAX |      |
|                 | Pulse duration | RCLK or SRCLK high or low           | 7                  |     | 7.5    |      | 7.5                |     | 8.5                   |     | 20   |
| t <sub>w</sub>  | Pulse duration | RCKR or SCRCLR low                  | 6                  |     | 6.5    |      | 6.5                |     | 7.5                   |     | ns   |
|                 |                | SER before SRCLK↑                   | 5.5                |     | 5.5    |      | 5.5                |     | 6                     |     |      |
|                 |                | SRCLK↑ before RCLK↑                 | 8                  |     | 9      |      | 9                  |     | 10                    |     |      |
| t <sub>su</sub> | Setup time     | SCRCLR low before RCLK↑(1)          | 8.5                |     | 9.5    |      | 9.5                |     | 10.5                  |     | ns   |
| *su             | Cotap time     | SRCLR high (inactive) before SRCLK↑ | 6                  |     | 6.8    |      | 6.8                |     | 7.5                   |     | 110  |
|                 |                | RCLK high (inactive) before RCLK↑   | 6.7                |     | 7.6    |      | 7.6                |     | 8.5                   |     |      |
| t <sub>h</sub>  | Hold time      | SER after SRCLK↑                    | 1.5                |     | 1.5    |      | 1.5                |     | 2                     |     | ns   |

<sup>(1)</sup> This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

## 6.10 Timing Requirements: $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$

over recommended operating free-air temperature range,  $V_{CC}$  = 3.3 V ± 0.3 V. See Figure 1.

|                 |                |  | T <sub>A</sub> = 2 | 5°C | SN54LV | 594A | SN74LV5<br>-40°C TO |     | SN74LV594A<br>-40°C TO 125°C |     | UNIT |
|-----------------|----------------|--|--------------------|-----|--------|------|---------------------|-----|------------------------------|-----|------|
|                 |                |  | MIN                | MAX | MIN    | MAX  | MIN                 | MAX | MIN                          | MAX |      |
|                 | Dules duration | RCLK or SRCLK high or low              | 5.5                |     | 5.5    |      | 5.5                 |     | 6.5                          |     |      |
| t <sub>w</sub>  | Pulse duration | RCKR or SCRCLR low                     | 5                  |     | 5      |      | 5                   |     | 6                            |     | ns   |
|                 |                | SER before SRCLK↑                      | 3.5                |     | 3.5    |      | 3.5                 |     | 4                            |     |      |
|                 |                | SRCLK↑ before RCLK↑                    | 8                  |     | 8.5    |      | 8.5                 |     | 9.5                          |     |      |
| t <sub>su</sub> | Setup time     | SCRCLR low before RCLK↑ <sup>(1)</sup> | 8                  |     | 9      |      | 9                   |     | 10                           |     | ns   |
| *Su             | ·              | SRCLR high (inactive) before SRCLK↑    | 4.2                |     | 4.8    |      | 4.8                 |     | 5.5                          |     |      |
|                 |                | RCLK high (inactive) before RCLK↑      | 4.6                |     | 5.3    |      | 5.3                 |     | 6                            |     |      |
| t <sub>h</sub>  | Hold time      | SER after SRCLK↑                       | 1.5                |     | 1.5    |      | 1.5                 |     | 2                            |     | ns   |

<sup>(1)</sup> This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.



## 6.11 Timing Requirements: $V_{cc} = 5 \text{ V} \pm 0.5 \text{ V}$

over recommended operating free-air temperature range,  $V_{CC}$  = 2.5 V ± 0.2 V. See Figure 1.

|                 |                |  | T <sub>A</sub> = 2 | 5°C | SN54LV | 594A | SN74LV5<br>-40°C TO |     | SN74LV594A<br>-40°C TO 125°C |     | UNIT |  |
|-----------------|----------------|--|--------------------|-----|--------|------|---------------------|-----|------------------------------|-----|------|--|
|                 |                |  | MIN                | MAX | MIN    | MAX  | MIN                 | MAX | MIN                          | MAX |      |  |
|                 | Pulse duration | RCLK or SRCLK high or low              | 5                  |     | 5      |      | 5                   |     | 6                            |     | 200  |  |
| t <sub>w</sub>  | Pulse duration | RCKR or SCRCLR low                     | 5.2                |     | 5.2    |      | 5.2                 |     | 6.2                          |     | ns   |  |
|                 |                | SER before SRCLK↑                      | 3                  |     | 3      |      | 3                   |     | 3.5                          |     |      |  |
|                 |                | SRCLK↑ before RCLK↑                    | 5                  |     | 5      |      | 5                   |     | 6                            |     |      |  |
| t <sub>su</sub> | Setup time     | SCRCLR low before RCLK↑ <sup>(1)</sup> | 5                  |     | 5      |      | 5                   |     | 5.5                          |     | ns   |  |
| *su             | Setup time     | SRCLR high (inactive) before SRCLK↑    | 2.9                |     | 3.3    |      | 3.3                 |     | 4                            |     | 115  |  |
|                 |                | RCLK high (inactive) before RCLK↑      | 3.2                |     | 3.7    |      | 3.7                 |     | 4.5                          |     |      |  |
| t <sub>h</sub>  | Hold time      | SER after SRCLK↑                       | 2                  |     | 2      |      | 2                   |     | 2.5                          |     | ns   |  |

<sup>(1)</sup> This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

### 6.12 Noise Characteristics<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted),  $V_{CC} = 3.3 \text{ V}$ ,  $C_L = 50 \text{ pF}$ ,  $T_A = 25^{\circ}\text{C}$ 

|             | PARAMETER                                     | MIN  | TYP  | MAX  | TINU |
|-------------|---|------|------|------|------|
| $V_{OL(P)}$ | Quiet output, maximum dynamic V <sub>OL</sub> |      | 0.5  | 0.8  | ٧    |
| $V_{OL(V)}$ | Quiet output, minimum dynamic V <sub>OL</sub> |      | -0.1 | -0.8 | ٧    |
| $V_{OH(V)}$ | Quiet output, minimum dynamic V <sub>OH</sub> |      | 2.8  |      | ٧    |
| $V_{IH(V)}$ | High-level dynamic input voltage              | 2.31 |      |      | ٧    |
| $V_{IL(V)}$ | Low-level dynamic input voltage               |      |      | 0.99 | V    |

<sup>(1)</sup> Characteristics are for surface-mount packages only.

### 6.13 Operating Characteristics

 $T_A = 25^{\circ}C$ 

|                 | PARAMETER                      | TEST CONDITIONS | V <sub>CC</sub> | TYP | UNIT |
|-----------------|--------------------------------|-----------------|-----------------|-----|------|
| C <sub>pd</sub> | Davies dissipation associtance | f 40 MH-        | 3.3 V           | 93  | F    |
|                 | Power dissipation capacitance  | f = 10 MHz      | 5 V             | 112 | pF   |



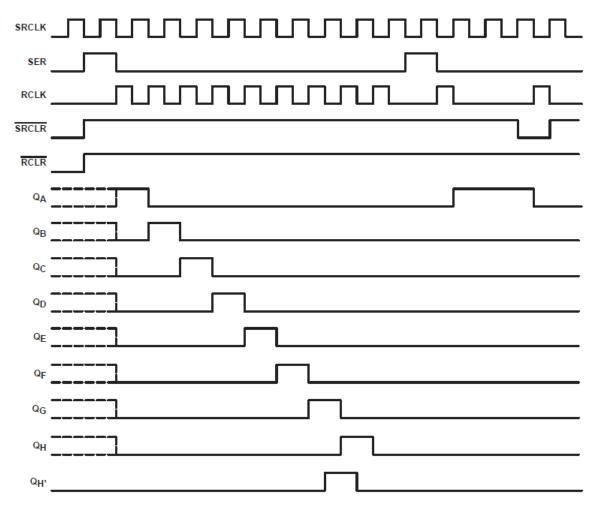
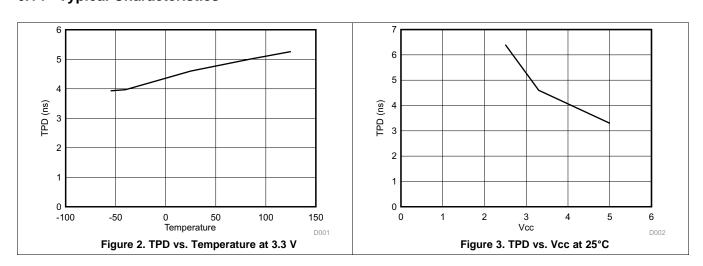


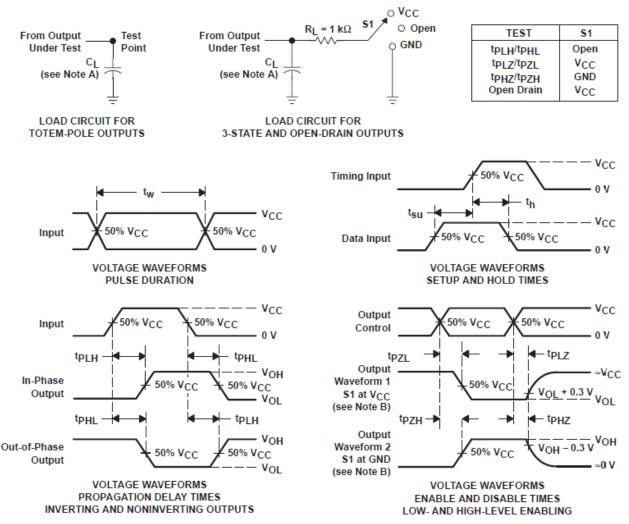
Figure 1. Timing Diagram

## 6.14 Typical Characteristics





#### 7 Parameter Measurement Information



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \le 1 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_f \le 3 \text{ ns}$ ,  $t_f \le 3 \text{ ns}$ .
  - D. The outputs are measured one at a time, with one input transition per measurement.
  - E. tpl z and tpHz are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpHL and tpLH are the same as tpd.
  - H. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms



#### 8 Detailed Description

#### 8.1 Overview

The SN74LV594A devices are 8-bit shift registers designed for 2-V to 5.5-V V<sub>CC</sub> operation.

These devices contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. Separate clocks (RCLK, SRCLK) and direct overriding clear (RCLR, SRCLR) inputs are provided on the shift and storage registers. A serial output  $(Q_{H'})$  is provided for cascading purposes. The shift-register (SRCLK) and storage-register (RCLK) clocks are positive-edge triggered. If the clocks are tied together, the shift register always is one clock pulse ahead of the storage register.



## 8.2 Functional Block Diagram

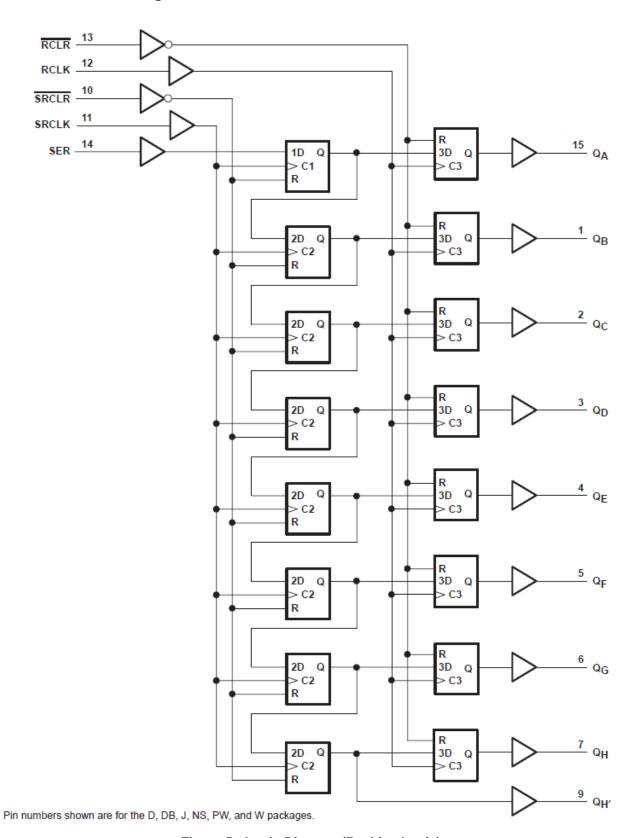


Figure 5. Logic Diagram (Positive Logic)



### 8.3 Feature Description

The device's wide operating range allows it to be used in a variety of systems that use different logic levels. The low propagation delay allows fast switching and higher speeds of operation. In addition, the low ground bounce stabilizes the performance of non-switching outputs while another output is switching.

#### 8.4 Device Functional Modes

**Table 1. Function Table** 

|     |          | INPUTS |          |      | FUNCTION  |
|-----|----------|--------|----------|------|---|
| SER | SRCLK    | SRCLR  | RCLK     | RCLR | FUNCTION  |
| Х   | X        | L      | X        | X    | Shift register is cleared.  |
| L   | 1        | Н      | X        | X    | First stage of shift register goes low. Other stages store the data of previous stage, repectively.   |
| Н   | 1        | Н      | Х        | Х    | First stage of shift register goes high. Other stages store the data of previous stage, respectively. |
| L   | <b>1</b> | Н      | Х        | Х    | Shift register state is not changed.  |
| X   | X        | X      | X        | L    | Storage register is cleared.  |
| Х   | X        | X      | <b>↑</b> | Н    | Shift register data is stored in the storage register.  |
| Х   | X        | X      | <b></b>  | Н    | Storage register state is not changed.  |



## **Application and Implementation**

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 Application Information

The SN74LV594A is a low drive CMOS device that can be used for a multitude of bus interface type applications where output ringing is a concern. The low drive and slow edge rates will minimize overshoot and undershoot on the outputs.

### 9.2 Typical Application

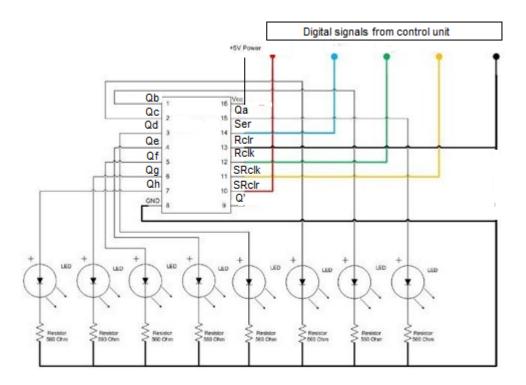


Figure 6. Typical Application Schematic

#### 9.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive will also create fast edges into light loads so consider routing and load conditions to prevent ringing.



## **Typical Application (continued)**

#### 9.2.2 Detailed Design Procedure

- · Recommended input conditions:
  - Rise time and fall time specs. See  $(\Delta t/\Delta V)$  in *Recommended Operating Conditions*.
  - Specified high and low levels. See (V<sub>IH</sub> and V<sub>IL</sub>) in *Recommended Operating Conditions*.
  - Inputs are overvoltage tolerant allowing them to go as high as 5.5 V at any valid V<sub>CC</sub>.
- · Recommended output conditions:
  - Load currents should not exceed 25 mA per output and 50 mA total for the part.
  - Outputs should not be pulled above V<sub>CC</sub>.

### 9.2.3 Application Curves

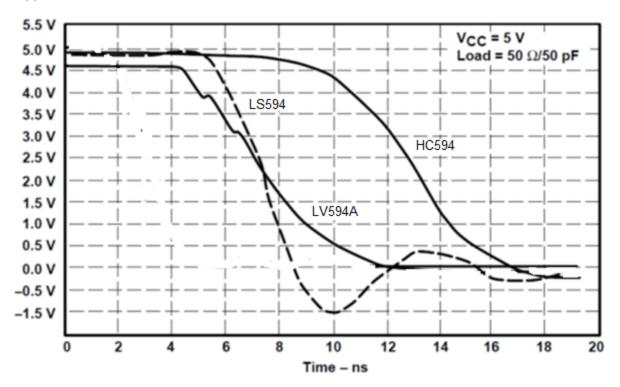


Figure 7. Switching Characteristics Comparison



### 10 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions*. Each  $V_{CC}$  terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, TI recommends a 0.1- $\mu$ F capacitor and if there are multiple  $V_{CC}$  terminals then TI recommends a 0.01- $\mu$ F or 0.022- $\mu$ F capacitor for each power terminal. Multiple bypass capacitors can be paralleled to reject different frequencies of noise. Frequencies of 0.1  $\mu$ F and 1  $\mu$ F are commonly used in parallel. The bypass capacitor should be installed as close as possible to the power terminal for best results.

### 11 Layout

#### 11.1 Layout Guidelines

When using multiple bit logic devices inputs should not ever float.

In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only three of the four buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. Specified below are the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or V<sub>CC</sub> whichever make more sense or is more convenient. Floating outputs is generally acceptable, unless the part is a transceiver. If the transceiver has an output enable pin it will disable the outputs section of the part when asserted. This will not disable the input section of the I.O's so they also cannot float when disabled.

#### 11.2 Layout Example

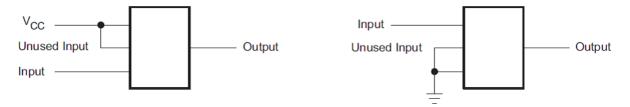


Figure 8. Layout Example



### 12 Device and Documentation Support

#### 12.1 Trademarks

All trademarks are the property of their respective owners.

#### 12.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.3 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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#### **PACKAGING INFORMATION**

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| SN74LV594AD      | ACTIVE     | SOIC         | D                  | 16   | 40             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594ADBR    | ACTIVE     | SSOP         | DB                 | 16   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594ADE4    | ACTIVE     | SOIC         | D                  | 16   | 40             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594ADG4    | ACTIVE     | SOIC         | D                  | 16   | 40             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594ADR     | ACTIVE     | SOIC         | D                  | 16   | 2500           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594APW     | ACTIVE     | TSSOP        | PW                 | 16   | 90             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594APWG4   | ACTIVE     | TSSOP        | PW                 | 16   | 90             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594APWR    | ACTIVE     | TSSOP        | PW                 | 16   | 2000           | RoHS & Green | NIPDAU   SN                   | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594APWRG4  | ACTIVE     | TSSOP        | PW                 | 16   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594APWT    | ACTIVE     | TSSOP        | PW                 | 16   | 250            | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |
| SN74LV594APWTG4  | ACTIVE     | TSSOP        | PW                 | 16   | 250            | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV594A                  | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



## **PACKAGE OPTION ADDENDUM**

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- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device          | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LV594ADBR   | SSOP            | DB                 | 16 | 2000 | 330.0                    | 16.4                     | 8.35       | 6.6        | 2.4        | 12.0       | 16.0      | Q1               |
| SN74LV594ADR    | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LV594APWR   | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV594APWR   | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV594APWRG4 | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV594APWT   | TSSOP           | PW                 | 16 | 250  | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |



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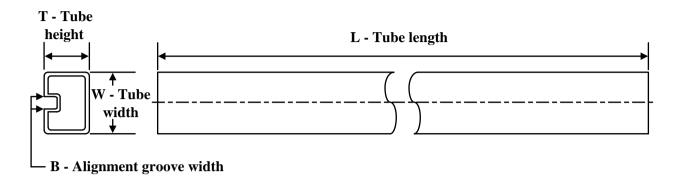
### \*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV594ADBR   | SSOP         | DB              | 16   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV594ADR    | SOIC         | D               | 16   | 2500 | 340.5       | 336.1      | 32.0        |
| SN74LV594APWR   | TSSOP        | PW              | 16   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV594APWR   | TSSOP        | PW              | 16   | 2000 | 364.0       | 364.0      | 27.0        |
| SN74LV594APWRG4 | TSSOP        | PW              | 16   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV594APWT   | TSSOP        | PW              | 16   | 250  | 356.0       | 356.0      | 35.0        |

## **PACKAGE MATERIALS INFORMATION**

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#### **TUBE**



\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74LV594AD    | D            | SOIC         | 16   | 40  | 507    | 8      | 3940   | 4.32   |
| SN74LV594ADE4  | D            | SOIC         | 16   | 40  | 507    | 8      | 3940   | 4.32   |
| SN74LV594ADG4  | D            | SOIC         | 16   | 40  | 507    | 8      | 3940   | 4.32   |
| SN74LV594APW   | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN74LV594APWG4 | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |

## D (R-PDS0-G16)

### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# D (R-PDSO-G16)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-150.





NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



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